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Diodes Incorporated DMN3018SSD-13

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Datasheet of DMN3018SSD-13 - MOSFET 2N-CH 30V 6.7A 8SO

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DMN3018SSD

#### 30V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>(BR)DSS</sub>	ss $R_{DS(ON)}$ max $I_D$ max $T_A = +28$	
30V	22mΩ @ V <sub>GS</sub> = 10V	6.7A
	$30m\Omega$ @ $V_{GS} = 4.5V$	5.2A

### **Description**

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(ON)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- Backlighting
- Power Management Functions
- DC-DC Converters

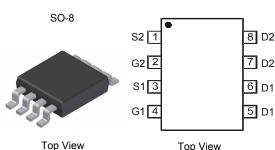
#### **Features**

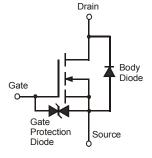
- Low On-Resistance
- 100% UIS (Avalanche) Rated
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (approximate)







Top View Pin Configuration

Equivalent Circuit per Element

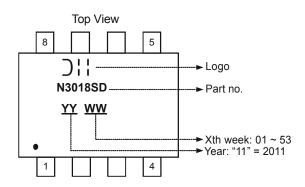
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3018SSD-13	SO-8	2500/Tape & Reel

Notes

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



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### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units	
Drain-Source Voltage			V <sub>DSS</sub>	30	V	
Gate-Source Voltage			V <sub>GSS</sub>	±20	V	
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	6.7 5.3	А	
	t < 10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	8.7 6.9	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	60	Α	
Maximum Body Diode continuous Current			Is	2.0	Α	
Avalanche Current (Note 6) L = 0.1mH			I <sub>AR</sub>	19	Α	
Repetitive Avalanche Energy (Note 6) L = 0.1mH			E <sub>AR</sub>	18	mJ	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)		$P_{D}$	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	0	83	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction to Case (Note 5)	$R_{ heta JC}$	14.5	°C/W	
Operating and Storage Temperature Range		$T_{J_{I}}T_{STG}$	-55 to +150	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		_	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	1.7	2.1	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			16	22	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	_	23	30	11122	$V_{GS} = 4.5V, I_D = 6A$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	8.3	_	S	$V_{DS} = 5V, I_{D} = 6.9A$	
Diode Forward Voltage	$V_{SD}$	0.5	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>		697	-		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	97	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	67	_			
Gate resistance	$R_g$	_	1.47	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_q$	_	6.0	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qq	_	13.2	_	nC	$V_{GS} = 10V, V_{DS} = 15V,$ $I_D = 9A$	
Gate-Source Charge	Qgs	_	2.2	_	IIC		
Gate-Drain Charge	$Q_{gd}$		1.8	_			
Turn-On Delay Time	t <sub>D(on)</sub>		4.3	_		$V_{DD}$ = 15V, $V_{GS}$ = 10V, $R_{L}$ = 15 $\Omega$ , $I_{D}$ = 1A, $R_{G}$ = 6 $\Omega$	
Turn-On Rise Time	t <sub>r</sub>		4.4	_			
Turn-Off Delay Time	t <sub>D(off)</sub>		20.1	_	ns		
Turn-Off Fall Time	t <sub>f</sub>	_	4.1	_			
Reverse Recovery Time	t <sub>rr</sub>	_	7.3	_	ns		
Reverse Recovery Charge	Q <sub>rr</sub>	-	7.9	_	nC	I <sub>F</sub> = 9A, di/dt = 500A/μs	

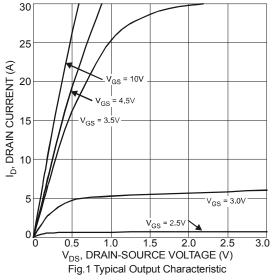
Notes:

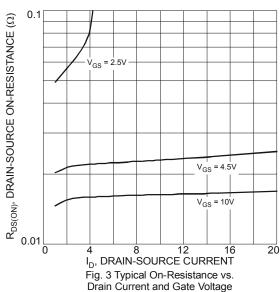
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 6.  $I_{AR}$  and  $E_{AR}$  rating are based on low frequency and duty cycles to keep  $T_J$  = +25°C 7. Short duration pulse test used to minimize self-heating effect.

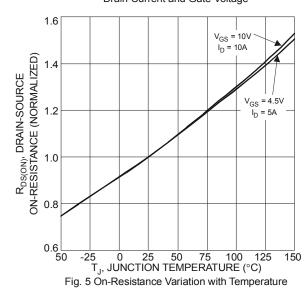
- 8. Guaranteed by design. Not subject to product testing.



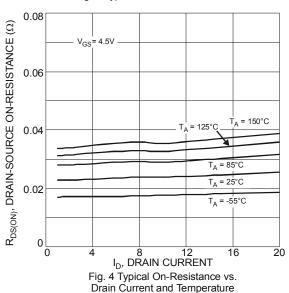
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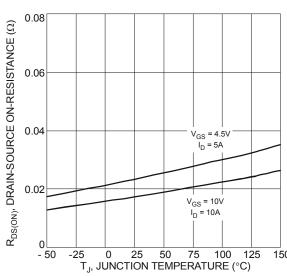






20  $V_{DS} = 5.0V$ 16 ID, DRAIN CURRENT (A) 12 T<sub>A</sub> = 150°C T<sub>A</sub> = 125°C = 25°C = -55°C 0 ō 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 V<sub>GS</sub>, GATE-SOURCE VOLTAGE Fig.2 Typical Transfer Characteristics





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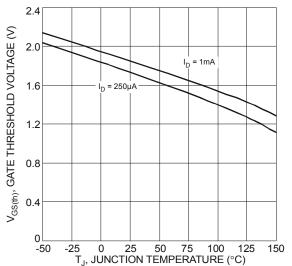
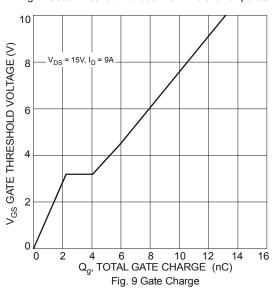
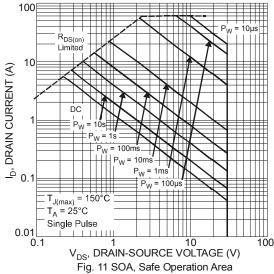
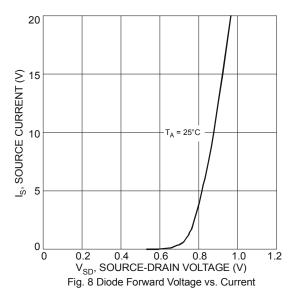
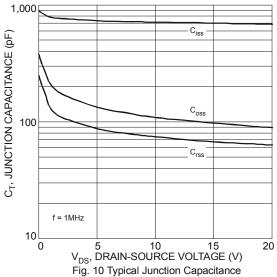


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



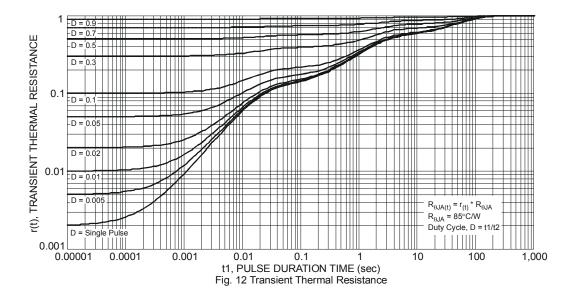






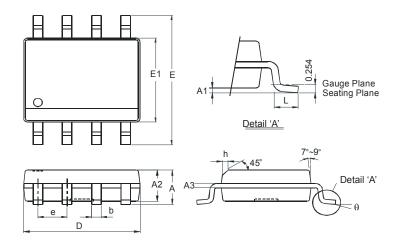


**DMN3018SSD** 



### **Package Outline Dimensions**

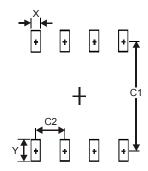
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
<b>A</b> 1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
Г	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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